## M57L5111P

## TECHNICAL DATA



## White LED 5 mm, InGaN

## Features

- High Luminous LEDs
- 5 mm Round Standard Directivity
- Long Lifetime Operation
- Superior Weather-resistance
- UV Resistant Epoxy
- Water Clear Type


## Applications

- Automotive Dashboard Lighting
- Small Area Illuminations
- Back Lighting
- Other Lighting

Diretivity:


## Absolute Maximum Ratings ( $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

| Item | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Power Dissipation | $\mathrm{P}_{\mathrm{D}}$ | 190 | mW |
| Forward Current | $\mathrm{I}_{\mathrm{F}}$ | 50 | mA |
| Pulse Forward Current * | $\mathrm{I}_{\mathrm{FP}}$ | 120 | mA |
| Reverse Voltage | $\mathrm{V}_{\mathrm{R}}$ | 5 | V |
| Operating Temperature | $\mathrm{T}_{\text {opr }}$ | $-30 \ldots+85$ | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {stg }}$ | $-40 \ldots+100$ | ${ }^{\circ} \mathrm{C}$ |
| Soldering Temperature (5 sec.) | $\mathrm{T}_{\text {sol }}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

* pulse width max. 10 ms , duty ratio max. 1/10


## Outline Dimension:



Specifications ( $\boldsymbol{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )

| Item | Condition | Symbol | Min. | Typ. | Max. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Optical Specifications |  |  |  |  |  |  |
| Luminous Intensity ${ }^{* 1}$ | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}$ | $\mathrm{I}_{\mathrm{V}}$ | 25000 | 35000 | - | mcd |
| Chromatictiy <br> Coordinates ${ }^{* 2}$ | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}$ | x | - | 0.45 | - |  |
|  | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}$ | y | - | 0.41 | - |  |
| Viewing Angle | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}$ | $2 \Theta_{1 / 2}$ | - | 15 | - | deg |
| Electrical Specifications |  |  |  |  |  |  |
| Forward Voltage | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}$ | $\mathrm{U}_{\mathrm{F}}$ | 3.0 | 3.3 | 3.8 | V |
| Reverse Voltage | $\mathrm{U}_{\mathrm{F}}=5 \mathrm{~V}$ | $\mathrm{U}_{\mathrm{R}}$ | - | - | 10 | $\mu \mathrm{~A}$ |

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## Typical Performance Curves




Ambient Temperature Ta ( ${ }^{\circ}$ )


Relative Intensity-IF



Ambient Temperature $\mathrm{Ta}\left({ }^{\circ} \mathrm{C}\right)$
If_Ta


## Reliability Test Report

| Classification | Test Time | Test Condition |
| :---: | :---: | :---: |
| Endurance Test | Operation Life | $\begin{array}{\|l} \hline \mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA} \\ \mathrm{~T}_{\mathrm{a}}=25 \pm{ }^{\circ} \mathrm{C} \\ \text { Test Time }=1000 \mathrm{hrs}(-24 \mathrm{hrs},+72 \mathrm{hrs}) \\ \hline \end{array}$ |
|  | High Temerature High Humidity Storage | $\begin{aligned} & \text { R.H }=90 \sim 95 \% \\ & \mathrm{~T}_{\mathrm{a}}=65 \pm 5^{\circ} \mathrm{C} \\ & \text { Test Time }=240 \mathrm{hrs}(+2 \mathrm{hrs})^{\text {Ies }} \end{aligned}$ |
|  | High Temerature Storage | $\begin{aligned} & \mathrm{T}_{\mathrm{a}}=105 \pm 5^{\circ} \mathrm{C} \\ & \text { Test Time }=500 \mathrm{hrs}(-24 \mathrm{hrs},+48 \mathrm{hrs}) \end{aligned}$ |
|  | Low Temperature Storage | $\begin{aligned} & \mathrm{T}_{\mathrm{a}}=55 \pm 5^{\circ} \mathrm{C} \\ & \text { Test Time }=500 \mathrm{hrs}(-24 \mathrm{hrs},+48 \mathrm{hrs}) \end{aligned}$ |
| Environmental Test | Temperature Cycling | $105^{\circ} \mathrm{C} \sim 25^{\circ} \mathrm{C} \sim 55^{\circ} \mathrm{C} \sim 25^{\circ} \mathrm{C}$ 60 min 10 min 60 min 10 min 20 cycles |
|  | Thermal Shock | $105{ }^{\circ} \mathrm{C} \sim-55^{\circ} \mathrm{C}$ 10 min 10 min 10 cycles |
|  | Solder Resistance | $\begin{aligned} & \mathrm{T}_{\mathrm{a}}=260 \pm 5^{\circ} \mathrm{C} \\ & \text { Test Time }=10 \pm 1 \mathrm{sec} \\ & \hline \end{aligned}$ |
|  | Solderability | $\begin{aligned} & \mathrm{T}_{\mathrm{a}}=230 \pm 5^{\circ} \mathrm{C} \\ & \text { Test Time }=5 \pm 1 \mathrm{sec} \end{aligned}$ |

## Judgement Criteria Of Falure For The Reliability

| Measuring Time | Symbol | Conditions | Failure |
| :---: | :---: | :---: | :---: |
| Luminous Intensity | $\mathrm{I}_{V}$ | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~mA}$ | $\mathrm{I}_{V}<0.5^{*}$ Initial Value |
| Forward Voltage | $\mathrm{U}_{F}$ | $\mathrm{I}_{F}=50 \mathrm{~mA}$ | $\mathrm{U}_{\mathrm{F}}<1.2^{*}$ Initial Value |
| Reverse Current | $\mathrm{I}_{R}$ | $\mathrm{U}_{\mathrm{F}}=5 \mathrm{~V}$ | $\mathrm{I}_{\mathrm{R}}>2^{*}$ Spec |

## Operation Life Test Luminance Rate Curve



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## Precaution for Use

## 1. Cautions

- DO NOT look directly into the light or look through the optical system.


## 2. Lead Forming

- When forming leads, the leads should be bent at a point at least 3 mm from the base of the lead. DO NOT use the base of the leadframe as a fulcrum during lead forming.
- Lead forming should be done before soldering.
- DO NOT apply any bending stress to the base of the lead. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- When mounted the LEDs onto the printed circuit board, the holes on the circuit board should be exactly aligned with the leads of LEDs. If the LEDs are mounted with stress at the leads, it causes deterioration of the lead and it will degrade the LEDs.


## 3. Soldering Conditions

- Solder the LEDs no closer than 3 mm from the base of the lead.
- Recommended soldering conditions:

|  | Dip Soldering |
| :--- | :--- |
| Pre-Heat | $120^{\circ} \mathrm{C}$ Max. |
| Pre-Heat Time | 60 Seconds Max. |
| Solder Bath Temperature | $260^{\circ} \mathrm{C}$ Max. |
| Dipping Time | 5 Seconds Max. |
| Dipping Position | No lower than 3 mm from the base of the epoxy bulb |

- DO NOT apply any stress to the lead particularly when heat.
- The LEDs must not be reposition after soldering.
- After soldering the LEDs, the lead should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- Cut the LED leads at room temperature. Cutting the leads at high temperature may cause the failure of the LEDs.


## 4. Static Electricity

- The LEDs are very sensitive to Static Electricity and surge voltage. So it is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- All devices, equipment and machinery must be grounded properly. It is recommended that precautions should be taken against surge voltage to the equipment that mounts the LEDs.



## 5. Heat Generation

- The powered LEDs generate heat. Heat dissipation should be considered in the application design to avoid the environmental conditions for operation in excess of the absolute maximum ratings.


[^0]:    ${ }^{* 1}$ Tolerance of chromaticity coordinates is $\pm 10 \%$
    $*^{2}$ Tolerance of luminous intensity is $\pm 15 \%$

[^1]:    * Brun-in condition: 50 mA
    * Projection of Statistical Average Light Output Degradation Performance for LED Technology Extrapolated from Test Data.
    * According to outgoing Packaged Products Specification
    * MTBF:100,000hrs, $90 \%$ Confidence (A Failure is Any LED Which is Open, shorted or fails to Emit Light)
    * The Projected Data is Base on The Feature of LED Itself Under Normal Operation Conditions.
    * Any Improper Circuit Design or External Factors Might Cause a Different Result.

